DATA SHEET

PMBTH10
NPN 1 GHz general purpose switching transistor

Product specification
File under Discrete Semiconductors, SC14

September 1995

Philips
Semiconductors

PHILIPS

NPN 1 GHz general purpose switching transistor PMBTH10

FEATURES

- Low cost
- High power gain.

DESCRIPTION

The PMBTH10 is a general purpose silicon npn transistor, encapsulated in a SOT23 plastic envelope. Its pnp complement is the PMBTH81.

PINNING

PIN	DESCRIPTION
Code: V30	
1	base
2	emitter
3	collector

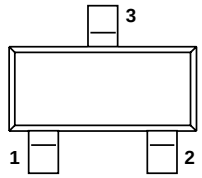


Fig.1 SOT23.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	30	V
V_{CEO}	collector-emitter voltage	open base	–	25	V
V_{EBO}	emitter-base voltage	open collector	–	3	V
P_{tot}	total power dissipation	T_s = 45 °C (note 1)	–	400	mW
h_{FE}	DC current gain	V_{CE} = 10 V; I_C = 4 mA	60	–	
C_{re}	collector-emitter feedback capacitance	V_{CB} = 10 V; I_E = 0; f = 1 MHz	–	0.7	pF
C_{rb}	collector-base feedback capacitance	V_{CB} = 10 V; I_E = 0; f = 1 MHz	0.35	0.65	pF
f_T	transition frequency	V_{CE} = 10 V; I_C = 4 mA; f = 100 MHz; T_{amb} = 25 °C	650	–	MHz
r_bC_c	collector-base time constant	V_{CE} = 10 V; I_C = 4 mA; f = 100 MHz; T_{amb} = 25 °C	–	9	ps

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	30	V
V_{CEO}	collector-emitter voltage	open base	–	25	V
V_{EBO}	emitter-base voltage	open collector	–	3	V
I_C	DC collector current		–	40	mA
P_{tot}	total power dissipation	T_s = 45 °C (note 1)	–	400	mW
T_{stg}	storage temperature		–65	150	°C
T_j	junction temperature		–	150	°C

Note

1. T_s is the temperature at the soldering point of the collector tab.

THERMAL RESISTANCE

SYMBOL	PARAMETER	THERMAL RESISTANCE
$R_{th\ j\text{-}s}$	from junction to soldering point (note 1)	260 K/W

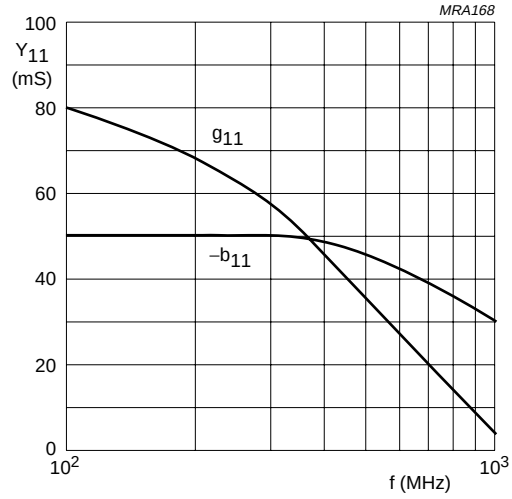
Note

1. T_s is the temperature at the soldering point of the collector tab.

CHARACTERISTICS

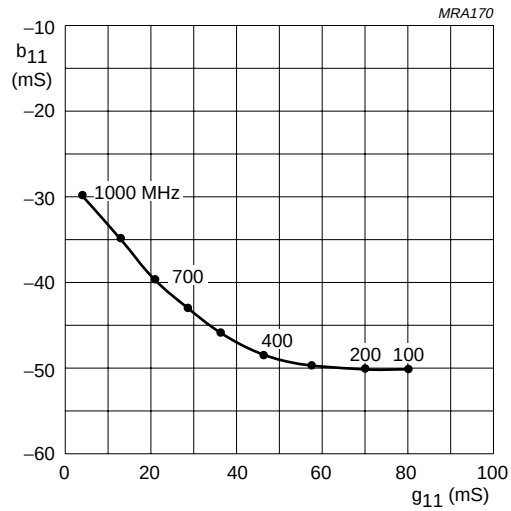
T_j = 25 °C.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{(BR)CBO}$	collector-base breakdown voltage	open emitter; I_C = 100 μA; I_E = 0	30	–	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	open base; I_C = 1 mA; I_B = 0	25	–	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	open collector; I_E = 10 μA; I_C = 0	3	–	V
$V_{CE\ sat}$	collector-emitter saturation voltage	I_C = 4 mA; I_B = 0.4 mA	–	0.5	V
$V_{BE\ on}$	base-emitter ON voltage	V_{CE} = 10 V; I_C = 4 mA	–	0.95	V
I_{CBO}	collector-base cut-off current	V_{CB} = 25 V; I_E = 0	–	100	nA
I_{EBO}	emitter-base cut-off current	V_{CB} = 25 V; I_C = 0	–	100	nA
h_{FE}	DC current gain	V_{CE} = 10 V; I_C = 4 mA	60	–	
C_{re}	collector-emitter feedback capacitance	V_{CB} = 10 V; $I_E = i_e$ = 0; f = 1 MHz	–	0.7	pF
C_{rb}	collector-base feedback capacitance	V_{CB} = 10 V; $I_C = i_c$ = 0; f = 1 MHz	0.35	0.65	pF
f_T	transition frequency	V_{CE} = 10 V; I_C = 4 mA; f = 100 MHz; T_{amb} = 25 °C	650	–	MHz
r_bC_c	collector-base time constant	V_{CB} = 10 V; I_C = 4 mA; f = 100 MHz; T_{amb} = 25 °C	–	9	ps



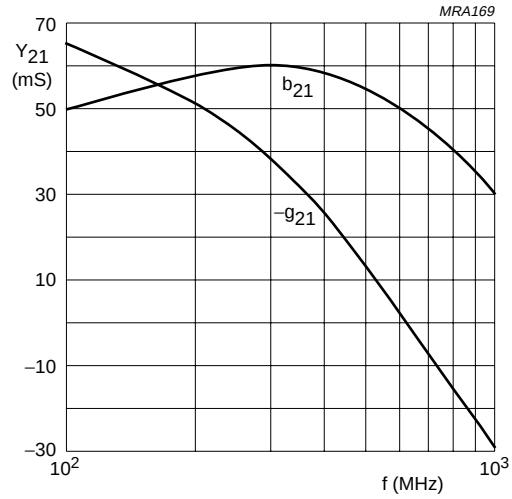
V_{CB} = 10 V; I_C = 4 mA.

Fig.2 Common base input admittance (Y_{11}) as a function of frequency.



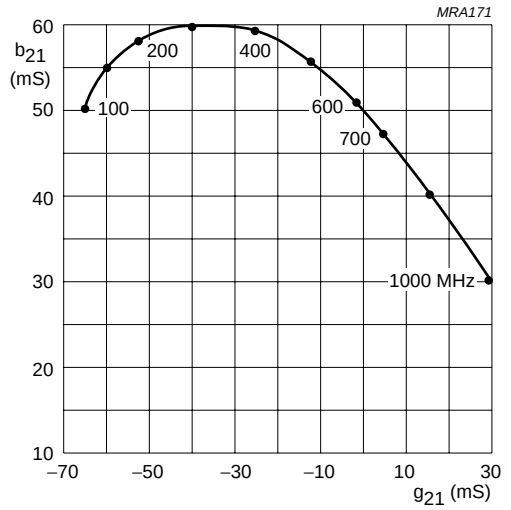
V_{CB} = 10 V; I_C = 4 mA.

Fig.3 Common base input admittance (Y_{11}).



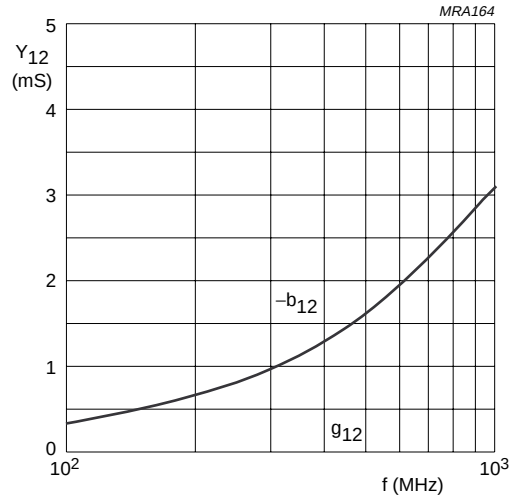
V_{CB} = 10 V; I_C = 4 mA.

Fig.4 Common base forward transfer admittance (Y_{21}) as a function of frequency.



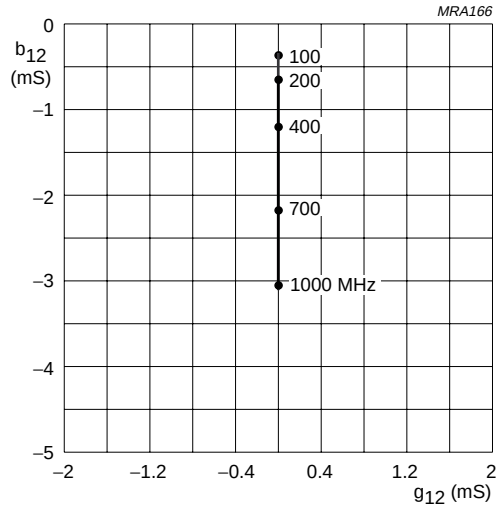
V_{CB} = 10 V; I_C = 4 mA.

Fig.5 Common base forward transfer admittance (Y_{21}).



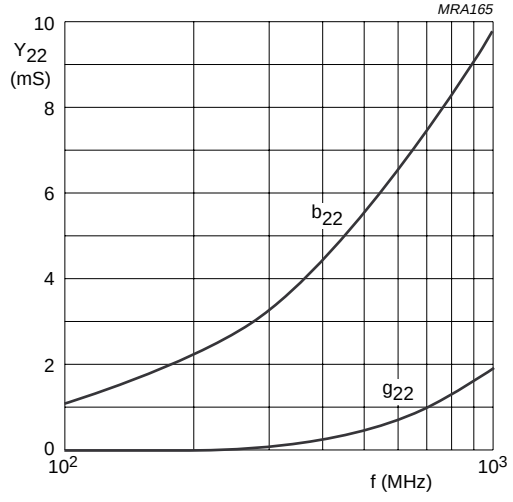
V_{CB} = 10 V; I_C = 4 mA.

Fig.6 Common base reverse transfer admittance (Y_{12}) as a function of frequency.



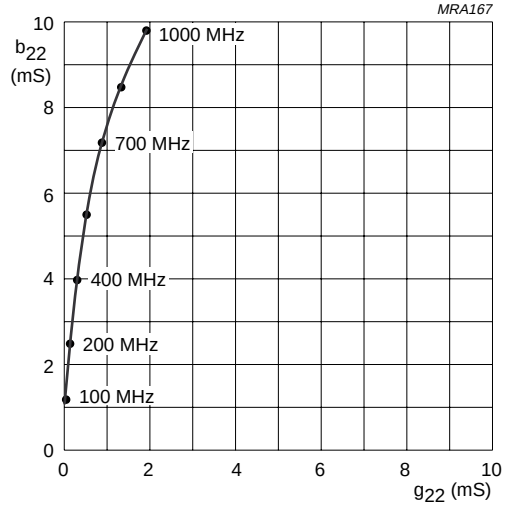
V_{CB} = 10 V; I_C = 4 mA.

Fig.7 Common base reverse transfer admittance (Y_{12}).



V_{CB} = 10 V; I_C = 4 mA.

Fig.8 Common base reverse admittance (Y_{22}) as a function of frequency.

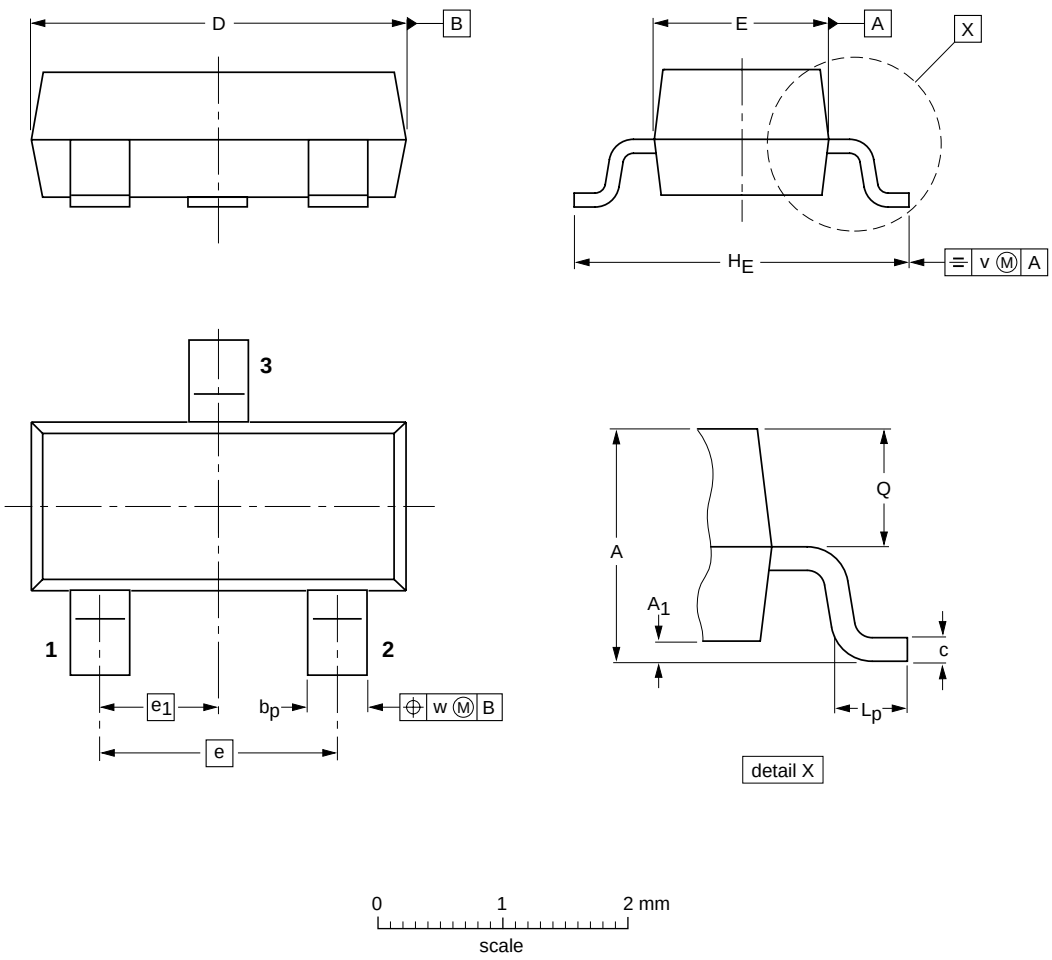


V_{CB} = 10 V; I_C = 4 mA.

Fig.9 Common base reverse admittance (Y_{22}).

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads **SOT23**



DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1 max.	b_p	c	D	E	e	e_1	H_E	L_p	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT23						97-02-28

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

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